Appl. No. 09/753,664; Group Art Unit: 2812

Dkt. No. 1875 0230000; Batch No.: N/A

Inventor(s): Liming Tsau; Tel: 202/371-2600

Title. High Density Metal Capacitor Using Via Etch Stopping

Layer as Field Dielectric in Dual-Damascence.

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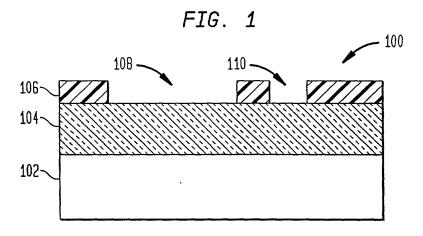
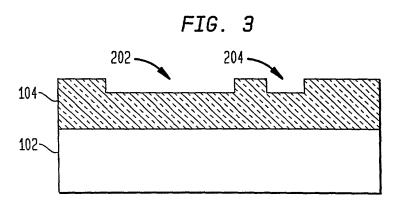


FIG. 2

202 204

106

104



Appl. No. 09/753.664: Group Ait Unit: 2812
Dkt. No. 1875.0230000, Batch No.: N/A
Inventor(s): Liming Tsau; Tel. 202/371-2600
Title: High Density Metal Capacitor Using Via Etch Stopping
Layer as Field Dielectric in Dual-Damascence . . .

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FIG. 4

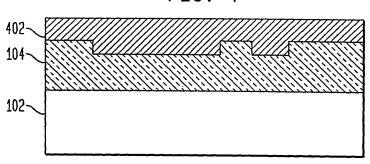


FIG. 5

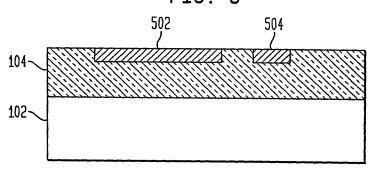
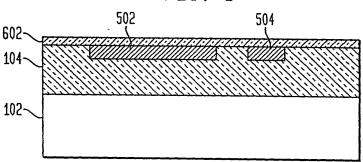
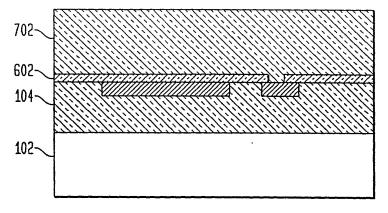


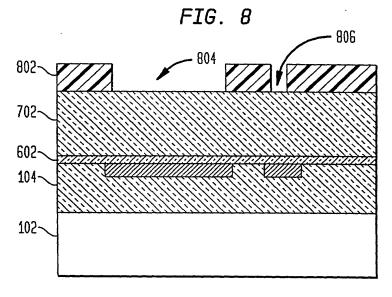
FIG. 6

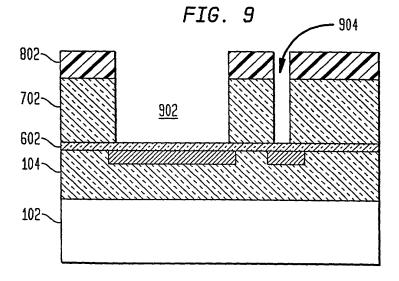


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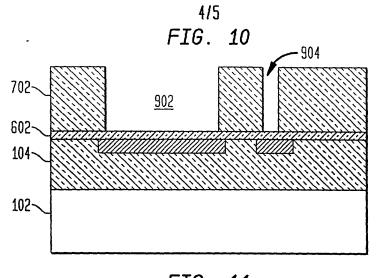
3/5 *FIG. 7* 

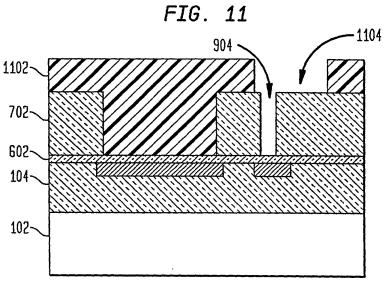


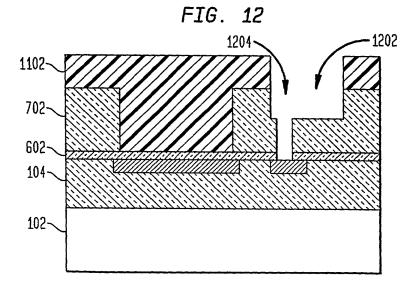




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